

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:
Chen, et al.

Serial No. 10/712460

Filed: November 13, 2003

For: SEMICONDUCTOR WAFER
MANUFACTURING METHODS
EMPLOYING CLEANING DELAY
PERIOD



§ Attorney Docket No. 24061.42
§
§ Customer No. 27683
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§ Group Art Unit: Unknown
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§ Examiner: Unknown
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LETTER TO THE OFFICIAL DRAFTSPERSON

Attn: Official Draftsperson
Commissioner For Patents
P. O. Box 1450
Alexandria, VA 22313-1450

Sir:

Enclosed are two (2) sheets of formal drawings to replace the informal drawings as originally filed in the above-identified patent application.

Respectfully submitted,

A handwritten signature in black ink, appearing to read "D. O'Dell".

David M. O'Dell
Reg. No. 42,044

Date: December 11, 2003
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File: 24061.42
R-62041

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to the Commissioner for Patents, P. O. Box 1450, Alexandria, VA 22313-1450 on December 11, 2003.

A handwritten signature in black ink, appearing to read "Gayle Conner".
Gayle Conner